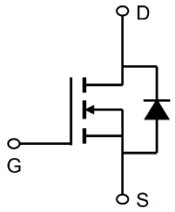
EVVOSEMI
THINK CHANGE DO

10N65F/P

650V N-Channel Enhancement Mode MOSFET

Description

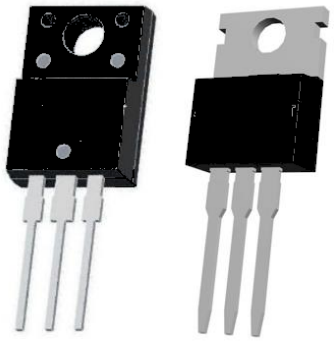
The AP10N65F/P is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.



General Features

V_{DS} = 650V I_D =10A

$R_{DS(ON)}$ < 0.9Ω @ V_{GS}=10V （Type：0.75Ω）



Application

Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Symbol	Parameter	Value	Unit
		TO-220F TO-220	
VDSS	Drain-Source Voltage (V_{GS} = 0V)	650	V
ID	Continuous Drain Current	10	A
IDM	Pulsed Drain Current (note1)	58	A
VGS	Gate-Source Voltage	±30	V
E_{AS}	Single Pulse Avalanche Energy (note2)	426	mJ
IAR	Avalanche Current (note1)	9	A
E_{AR}	Repetitive Avalanche Energy note1)	41	mJ
P_D	Power Dissipation (T_C = 25ºC)	32.1	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150	ºC
RthJC	Thermal Resistance, Junction-to-Case	4.46	ºC/W
RthJA	Thermal Resistance, Junction-to-Ambient	46.7	ºC/W

Electrical Characteristics (T_J=25℃, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	650	685	--	V
IDSS	Zero Gate Voltage Drain Current	V_{DS}= 650V, V_{GS}= 0V, T_J=25ºC	--	--	1	μA
IGSS	Gate-Source Leakage	V_{GS} = ±30V	--	--	±100	nA
VGS(th)	Gate-Source Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	2.0	--	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V_{GS} = 10V, I_D = 3.5A	--	0.75	0.9	Ω
C_{iss}	Input Capacitance	V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz	--	1037	--	pF
C_{oss}	Output Capacitance		--	138	--	
C_{rss}	Reverse Transfer Capacitance		--	5.3	--	
Q_g	Total Gate Charge	V_{DD}=520V, I_D = 9A, V_{GS} = 10V	--	19	--	nC
Q_{gs}	Gate-Source Charge		--	7.3	--	
Q_{gd}	Gate-Drain Charge		--	8.5	--	
td(on)	Turn-on Delay Time	V_{DD}=325V, I_D = 7A, R_G = 25Ω	--	18	--	ns
t_r	Turn-on Rise Time		--	30	--	
td(off)	Turn-off Delay Time		--	61	--	
t_f	Turn-off Fall Time		--	36	--	
IS	Continuous Body Diode Current	T_C = 25 ºC	--	--	9.0	A
ISM	Pulsed Diode Forward Current		--	--	36	A
V_{SD}	Body Diode Voltage	T_J = 25ºC, I_{SD} = 7A, V_{GS} = 0V	--	--	1.2	V
trr	Reverse Recovery Time	V_{GS} = 0V,I_S = 7A, di_F/dt =100A /μs	--	431	--	ns
Q_{rr}	Reverse Recovery Charge		--	2.6	--	μC

Note :

1、The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The EAS data shows Max. rating . IAS = 9.0A, VDD = 50V, RG = 25 Ω, Starting TJ = 25 ºC

3、The test condition is Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%

4、The power dissipation is limited by 150℃ junction temperature

5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Characteristics

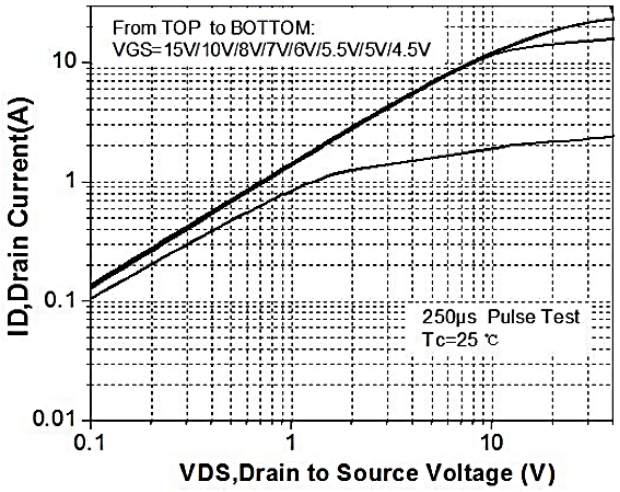


Figure 1. On-Region Characteristics

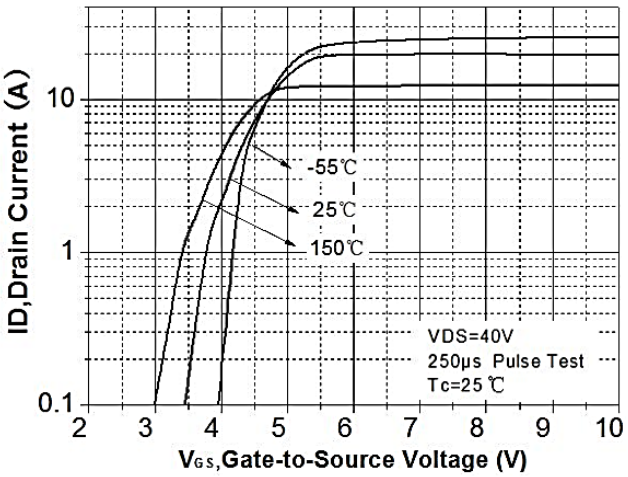


Figure 2. Transfer Characteristics

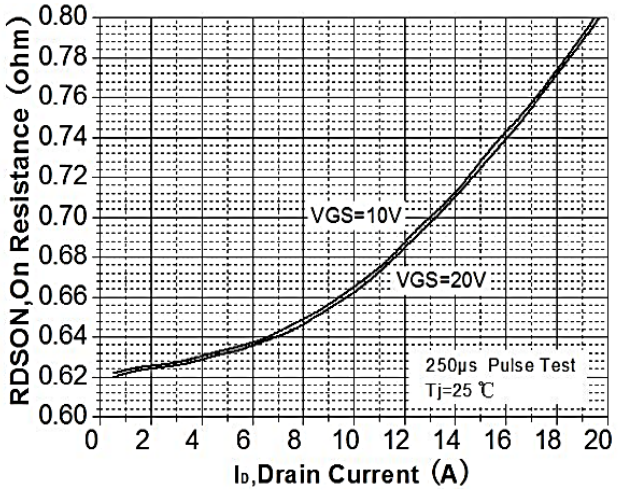


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

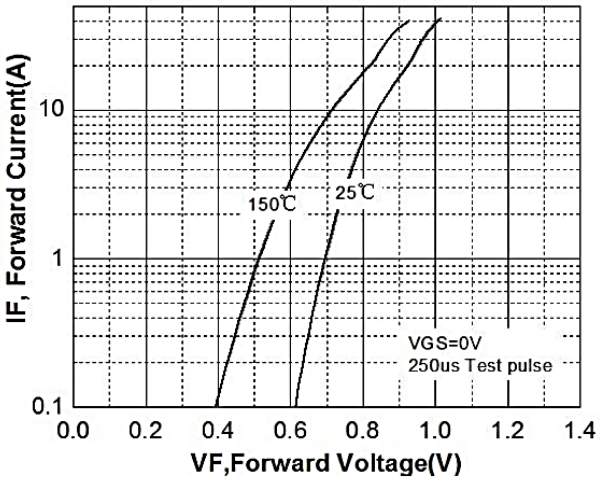


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

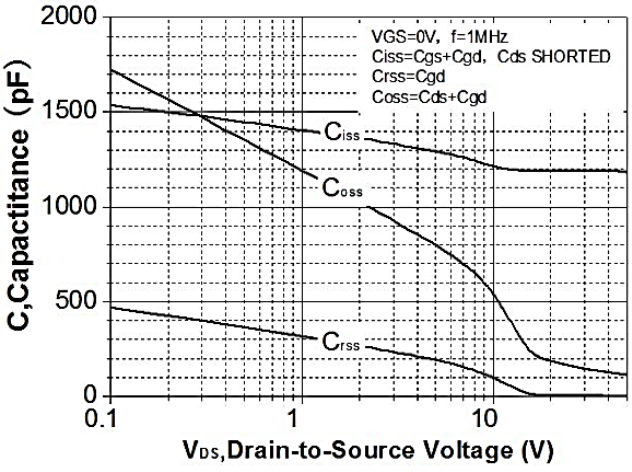


Figure 5. Capacitance Characteristics

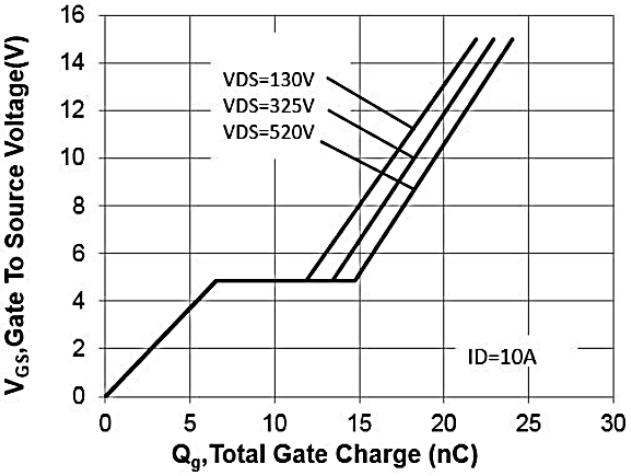
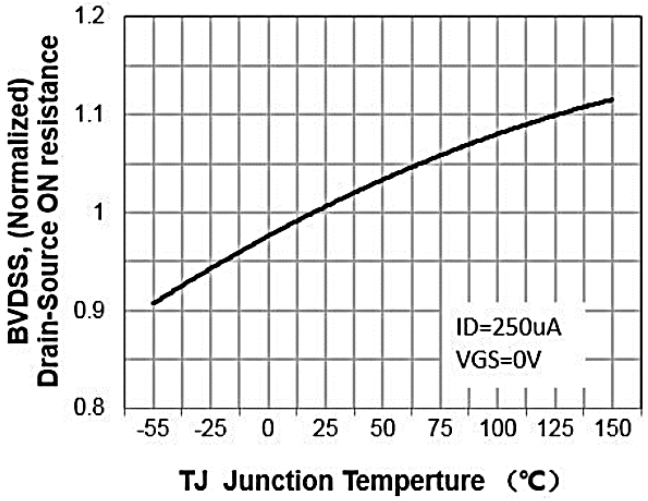


Figure 6. Gate Charge Characteristics



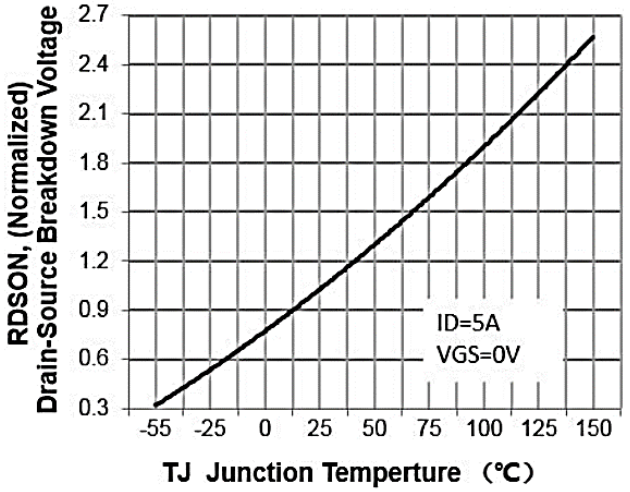
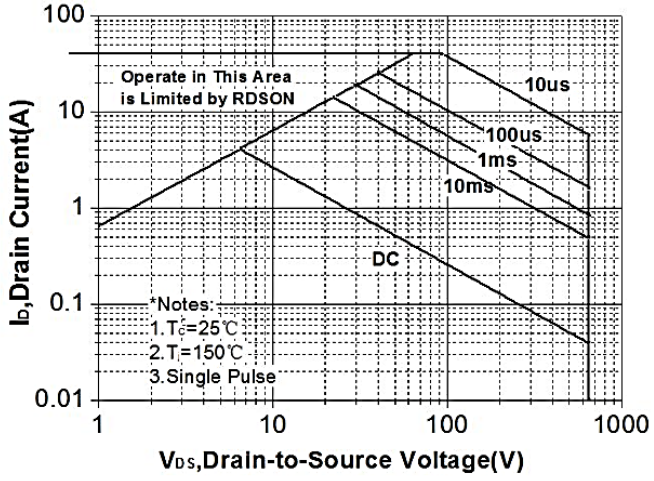


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



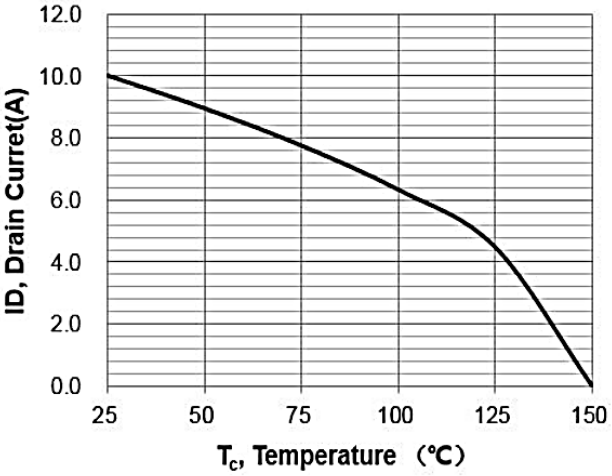


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

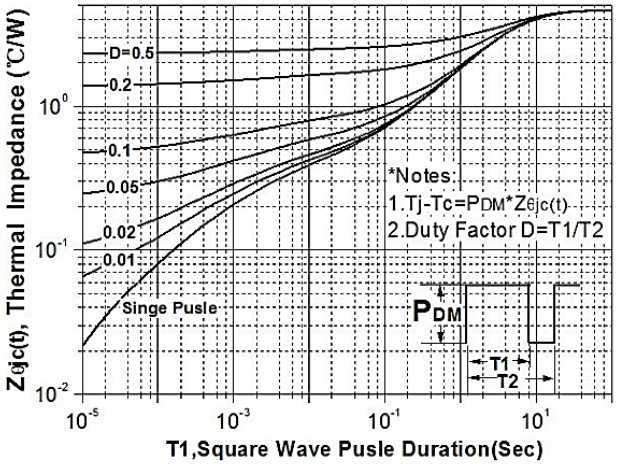
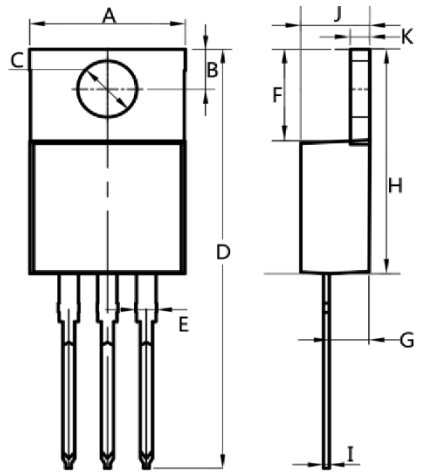


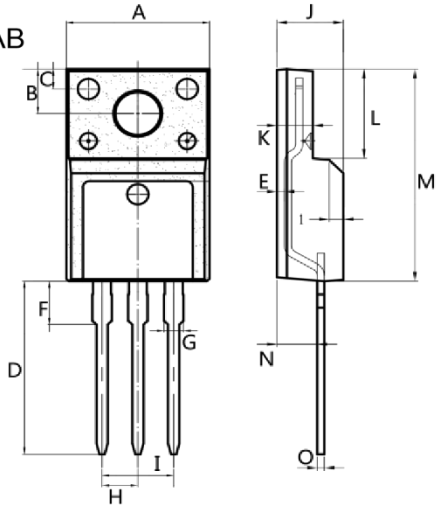
Figure 11. Transient Thermal Response Curve

TO-220AB



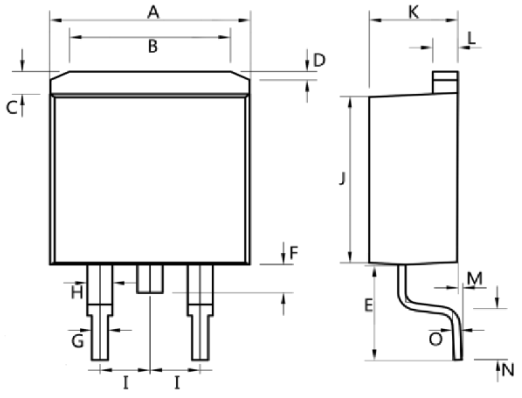
Dim.	Min.	Max.
A	10.0	10.4
B	2.5	3.0
C	3.5	4.0
D	28.0	30.0
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
H	15.0	16.0
I	0.35	0.45
J	4.3	4.7
K	1.2	1.4
All Dimensions in millimeter		

ITO-220AB



Dim.	Min.	Max.
A	9.9	10.3
B	2.9	3.5
C	1.15	1.45
D	12.75	13.25
E	0.55	0.75
F	3.1	3.5
G	1.25	1.45
H	Typ 2.54	
I	Typ 5.08	
J	4.55	4.75
K	2.4	2. 7
L	6.35	6.75
M	15.0	16.0
N	2.75	3.15
O	0.45	0.60
All Dimensions in millimeter		

TO-263



Dim.	Min.	Max.
A	10.0	10. 5
B	7.25	7.75
C	1.3	1.5
D	0.55	0.75
E	5.0	6.0
F	1.4	1.6
G	0.75	0.95
H	1.15	1.35
I	Typ 2.54	
J	8.4	8.6
K	4.4	4.6
L	1.25	1.45
M	0.02	0.1
N	2.4	2.8
O	0.35	0.45
All Dimensions in millimeter		